

REMARKS

Careful consideration has been given to the Official Action of June 6, 2006 and reconsideration of the application as amended is respectfully requested.

Claim Status

Claims 1-3, 5 and 6 have been rejected under 35 U.S.C. 103 as being unpatentable over Tanaka in view of Venkataswamy.

Claim 4 is rejected under 35 U.S.C. 103 as being unpatentable over Tanaka in view of Venkataswamy and further in view of Kito.

Amendatory Action and Argument

Claim 1 has been amended to incorporate the subject matter from Claim 2 therein. Claims 5 and 6 have been cancelled. The claims remaining for consideration are Claim 1 and dependent Claims 3 and 4.

In rejecting Claim 2, the Examiner states “the thickness of the layer [outermost] is considered to be really a choice of mechanical expedients where it is the outermost layer to an innermost layer of resin such as polyamide...”

It is respectfully submitted that the Examiner is incorrect in this assesement and attention is drawn to page 7, line 36 to page 8, line 5, where it is stated that

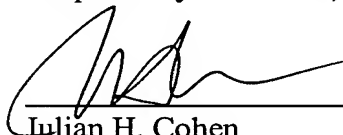
“It is expected that the thinner the impact-resistant layer, the lower is the impact resistance of the impact resistance. The results of impact tests prove this fact. However, it is not necessarily true that an impact-resistant layer having a greater thickness is desirable. A desirable thickness of the impact-resistant layer is in the range of 0.7 to 0.9 mm.”

It is therefore respectfully submitted that taking the above and Fig. 6 into account it does not follow that the thickness of the outermost layer is merely a choice of mechanical expedients and in fact is based on an unexpected and unusual result justifying the allowance of Claim 1.

It is not sufficient for the Examiner to arbitrarily assume that the thickness of the outermost layer is a mere mechanical expedient in the light of the teaching which is provided in the instant application.

It is therefore respectfully submitted that Claim 1 as now amended is in allowable condition along with dependent Claims 3 and 4.

Respectfully submitted,



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